



CARDEL 'CARDLAM WS' LAMINATION PAD

TECHNICAL DATA



Description:	High efficiency, low profile conductive polymer, card Lamination pad, designed for single stack and twin stack lamination. Compatible with "tilt trays" assembly systems.
Structure:	Conductive Silicon with re-inforced centre core
Weight:	approx 3000g/m ²
Thickness:	3mm - suitable for all types of medium / high volume Single and Twin stack laminators.
Size tolerance:	+/- 1mm
Squareness:	+/- 2mm per metre
Max Temperature peak:	220°C
Max Temperature continuous:	210°C
Max Pressure:	500 psi (35kg / cm ²)
Average recommended cycle:	15 - 22 mins
Typical Number of cycles:	5000 - 7000